POWERTIP TECH. CORP.

SPECIFICATIONS

CUSTOMER	:	PTC
SAMPLE CODE	:	SH800480T013-IBA01
MASS PRODUCTION CODE	:	PH800480T013-IBA01
SAMPLE VERSION	:	01
SPECIFICATIONS EDITION	:	003
DRAWING NO. (Ver.)	:	LMD-PH800480T013-IBA01 (Ver.004)
PACKAGING NO. (Ver.)	:	-

Customer Approved

Date:

Approved	Checked	Designer
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POWERTIP
2014.03.06
TW RD APR

■ Preliminary specification for design input

□ Specification for sample approval

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History of Version

Date (mm / dd / yyyy)	Ver.	Edi.	Description	Page	Design by
10/24/2013	01	001	New Drawing	-	Yuan
01/13/2014	01	002	Modify Optical Characteristics Modify Drawing	6 Appendix	Yuan
03/06/2014	01	003	Modify Drawing	Appendix	Yuan

Total: 26 Page

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1. SPECIFICATIONS

1.1 Features

Item	Standard Value
Display Type	800 * (RGB) * 480
LCD Type	a-Si TFT , Normally white , Transmissive type
Screen size(inch)	7.0 inch
Viewing Direction	6 O'clock
Backlight Type	LED B/L
Weight	TBD
Interface	RGB Interface
ROHS	THIS PRODUCT CONFORMS THE ROHS OF PTC Detail information please refer webside : http://www.powertip.com.tw/news.php?area_id_view=1085560481/

1.2 Mechanical Specifications

Item	Standard Value	Unit
Outline Dimension	164.9 (W) * 100.0 (L) *3.4 (H)	mm

LCD panel

Item	Standard Value	Unit
Active Area	154.08 (W) * 85.92 (L)	mm

Note：For detailed information please refer to LCM drawing.

1.3 Absolute Maximum Ratings

Module

Item	Symbol	Condition	Min.	Max.	Unit	Remark
Power Supply Voltage	DV_{DD}	GND=0	-0.3	5.0	V	-
	AV_{DD}		6.5	13.5	V	
	V_{GH}		-0.3	40	V	
	V_{GL}	AGND=0	-20	0.3	V	
	V_{GH} - V_{GL}	-	0	40	V	
Operating Temperature	T_{OP}	-	-20	60	°C	
Storage Temperature	T_{ST}	-	-30	70	°C	

The absolute maximum rating values of this product are not allowed to be exceeded at any times. Should a module be used with any of the absolute maximum ratings exceeded, the characteristics of the module may not be recovered, or in an extreme case, the module may be permanently destroyed.

1.4 DC Electrical Characteristics

Module GND = 0V, Ta = 25°C

Item	Symbol	Min.	Typ.	Max.	Unit	Remark
Supply Voltage	DV_{DD}	3.0	3.3	3.6	V	-
	V_{GH}	15.3	16.0	16.7		
	V_{GL}	-7.7	-7.0	-6.3		
	AV_{DD}	10.2	10.4	10.6		
VCOM	V_{COM}	-	3.9	-	V	
Input signal Voltage	V_{IH}	$0.7DV_{DD}$	-	DV_{DD}	V	
	V_{IL}	0	-	$0.3DV_{DD}$		
Supply Current	IDD	-	80	-	mA	Pattern= Full display
		-	80	120		Pattern= Black *1

Note1: Maximum current display.

1.5 Optical Characteristics

TFT LCD Module DV_{DD} = 3.3 V, Ta=25°C

Item		Symbol	Condition	Min.	Typ.	Max.	unit	
Response time	Rise	Tr	Ta = 25°C θX, θY = 0°	-	10	20	ms	Note 2
	Fall	Tf		-	15	30		
Viewing angle	Top	θY+	CR ≥ 10	40	50	-	Deg.	Note 4
	Bottom	θY-		60	70	-		
	Left	θX-		60	70	-		
	Right	θX+		60	70	-		
Contrast ratio		CR	Ta = 25°C θX , θY = 0°	200	250	-		Note 3
Color of CIE Coordinate （With B/L）	White	X		TBD	TBD	TBD	-	Note1
		Y		TBD	TBD	TBD		
	Red	X		TBD	TBD	TBD		
		Y		TBD	TBD	TBD		
	Green	X		TBD	TBD	TBD		
		Y		TBD	TBD	TBD		
	Blue	X		TBD	TBD	TBD		
		Y		TBD	TBD	TBD		
Average Brightness Pattern=white display (With TFT)*1		IV	-	TBD	500	-	cd/m^2	Note1
Uniformity (With TFT)*2		△B	-	70	-	-	%	Note1

Note 1:

*1：△B=B(min) / B(max) * 100%

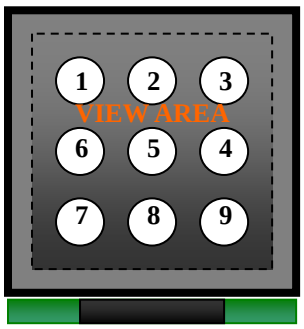
*2：Measurement Condition for Optical Characteristics:

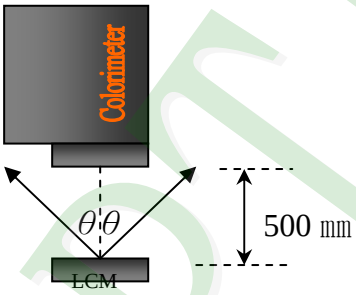
a：Environment: 25℃±5℃ / 60±20%R.H，no wind，dark room below 10 Lux at typical lamp current and typical operating frequency.

b：Measurement Distance: 500 ± 50 ㎜ ，(θ= 0°)

c：Equipment: TOPCON BM-7 fast，(field 1°)，after 10 minutes operation.

d：The uncertainty of the C.I.E coordinate measurement ±0.01，Average Brightness ± 4%





Colorimeter=BM-7 fast

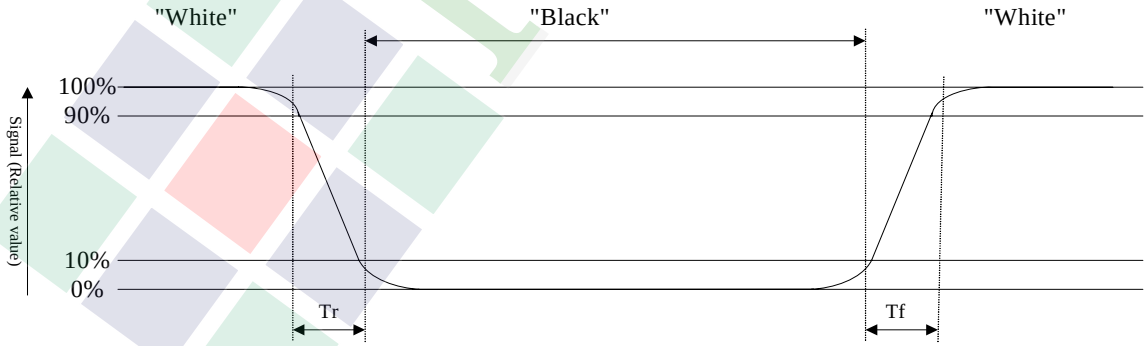
To be measured at the center area of panel with a viewing cone of 1° by Topcon luminance meter BM-7, after 10 minutes operation (module)

Note2: Definition of response time:

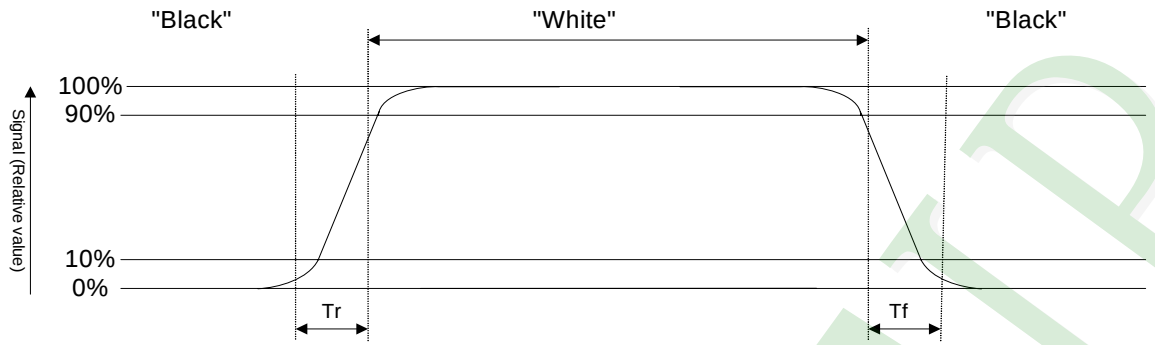
The output signals of photo detector are measured when the input signals are changed from “black” to “white”(falling time) and from “white” to “black”(rising time), respectively. The response time is defined as the time interval between the 10% and 90% of Amplitudes.

Refer to figure as below:

Normally White



Normally Black



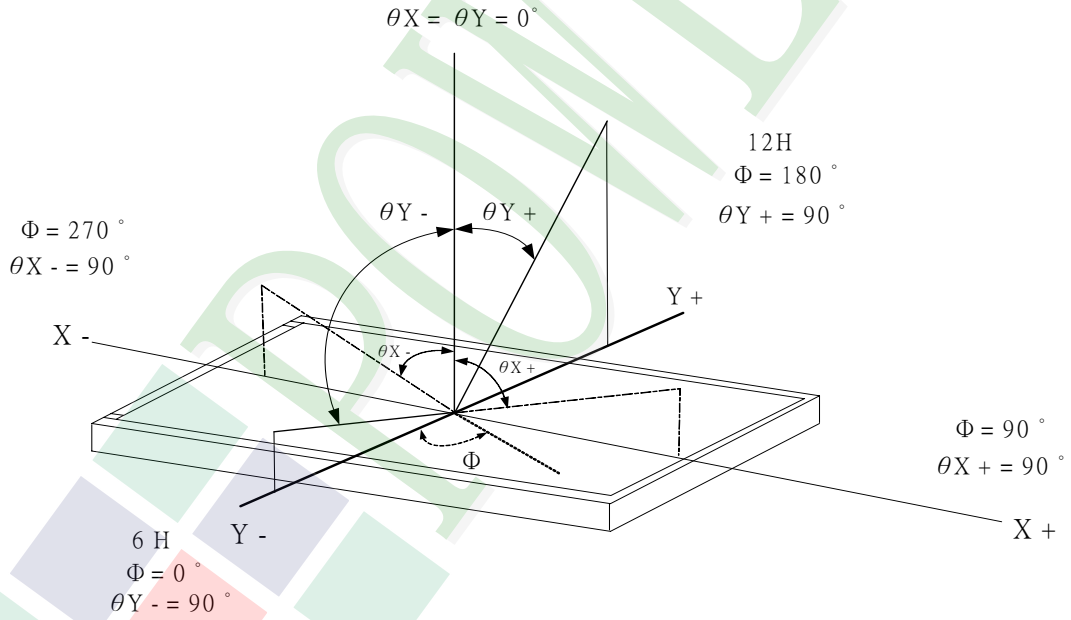
Note3: Definition of contrast ratio:

Contrast ratio is calculated with the following formula

$$\text{Contrast ratio (CR)} = \frac{\text{Photo detector output when LCD is at “White” state}}{\text{Photo detector output when LCD is at “Black” state}}$$

Note4: Definition of viewing angle:

Refer to figure as below:



1.6 Backlight Characteristics

Maximum Ratings

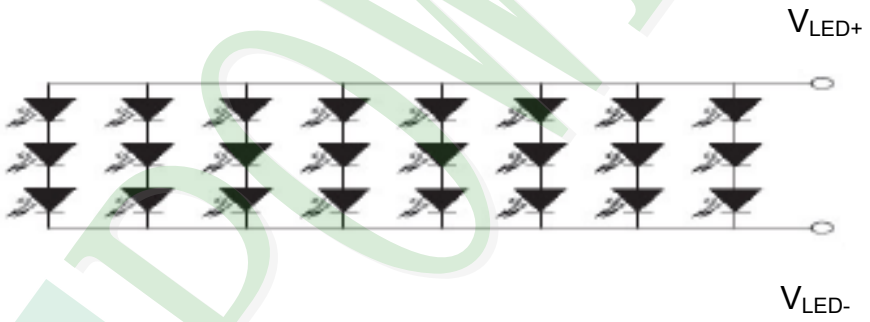
Item	Symbol	Min.	Max.	Unit	Remark
LED Forward Current	I_F	TBD		mA	One LED
LED Reverse Voltage	V_R	TBD		V	

Electrical / Optical Characteristics

Item	Symbol	Min.	Typ.	Max.	Unit	Remark
LED Voltage	V_L	TBD	TBD	TBD	V	Note1
LED Current	I_L	TBD	TBD	TBD	mA	-
LED life time	-	TBD	-	-	H_r	Note2

Note 1: The LED Supply Voltage is defined by the number of LED at Ta=25°C and I_L = TBD mA.

Note 2: The "LED life time" is defined as the module brightness decrease to 50% original brightness at Ta=25°C and I_L =160mA. The LED lifetime could be decreased if operating I_L is lager than 160mA.



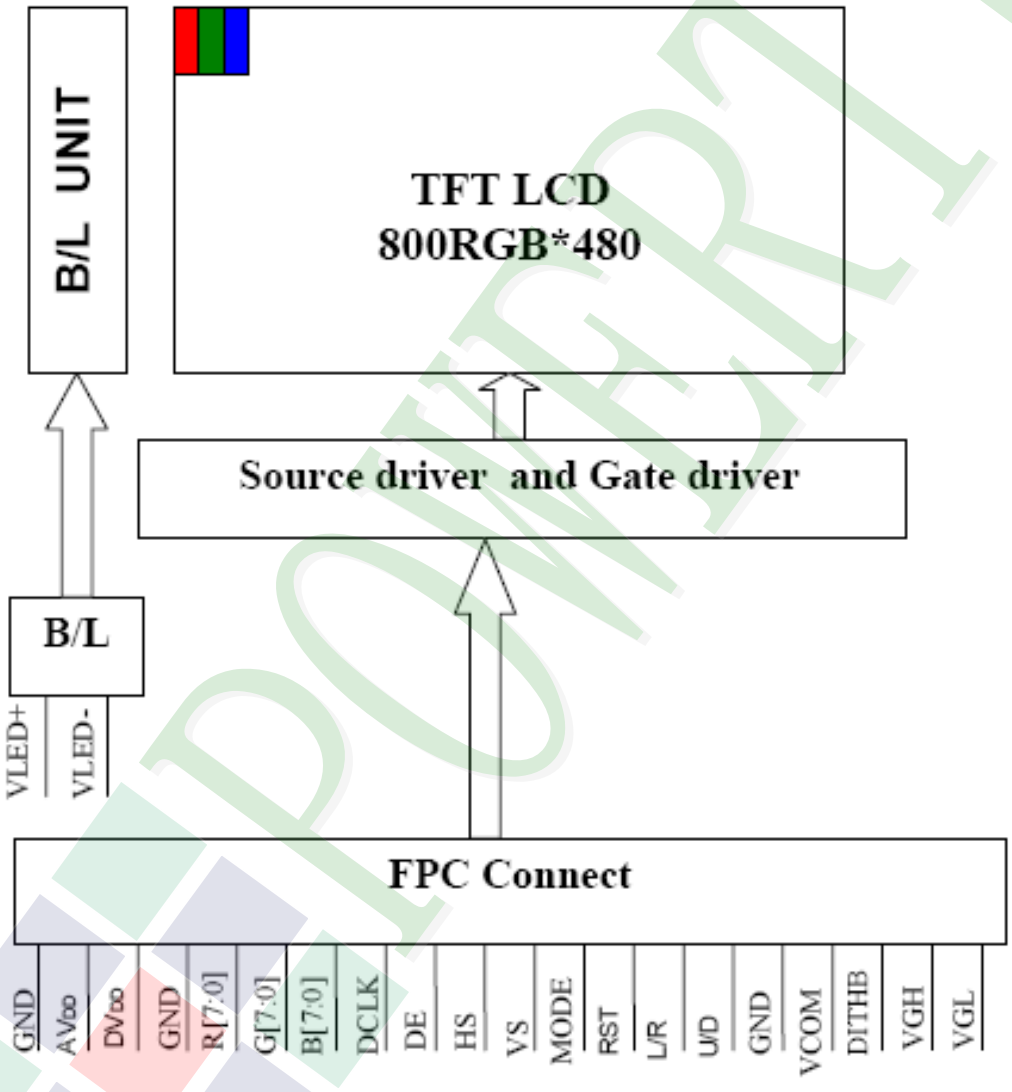
2. MODULE STRUCTURE

2.1 Counter Drawing

2.1.1 LCM Mechanical Diagram

* See Appendix

2.1.2 Block Diagram



2.2 Interface Pin Description

Pin NO.	SYMBOL	DESCRIPTION	Type:Remark
1	V_{LED+}	Power For LED backlight (+).	Power
2	V_{LED+}	Power For LED backlight (+).	Power
3	V_{LED-}	Power For LED backlight (-).	Power
4	V_{LED-}	Power For LED backlight (-).	Power
5	GND	Power ground.	Power
6	V_{com}	Common voltage.	I
7	DV_{DD}	Power for Digital Circuit.	I
8	MODE	DE/SYNC mode select.	I,Note 1
9	DE	Data Input Enable.	I
10	VS	Vertical Sync Input.	I
11	HS	Horizontal Sync Input.	I
12	B7	Blue Data(MSB).	I
13	B6	Blue Data.	I
14	B5	Blue Data.	I
15	B4	Blue Data.	I
16	B3	Blue Data.	I
17	B2	Blue Data.	I
18	B1	Blue Data.	I:Note 2
19	B0	Blue Data(LSB).	I:Note 2
20	G7	Green Data(MSB).	I
21	G6	Green Data.	I
22	G5	Green Data.	I
23	G4	Green Data.	I
24	G3	Green Data.	I
25	G2	Green Data.	I
26	G1	Green Data.	I:Note 2
27	G0	Green Data(LSB).	I:Note 2
28	R7	Red Data(MSB).	I
29	R6	Red Data.	I
30	R5	Red Data.	I
31	R4	Red Data.	I
32	R3	Red Data.	I
33	R2	Red Data.	I
34	R1	Red Data.	I:Note 2
35	R0	Red Data(LSB).	I:Note 2
36	GND	Power Ground	Power
37	DCLK	Sample clock	I:Note 3

Pin NO.	SYMBOL	DESCRIPTION	Type:Remark
38	GND	Power Ground.	Power
39	L/R	Left / right selection.	I:Note 4,5
40	U/D	Left / right selection.	I:Note 4,5
41	V_{GH}	Gate On Voltage.	Power
42	V_{GL}	Gate OFF Voltage.	Power
43	AV_{DD}	Power for Analog Circuit.	Power
44	RESET	Global reset pin.	I:Note 6
45	NC	No connection.	-
46	V_{COM}	Common Voltage.	I
47	DITHB	Dithering Function.	I:Note 7
48	GND	Power Ground.	Power
49	NC	No connection.	-
50	NC	No connection.	-

I:input

Note 1: DE/SYNC mode select. Normally pull high.
When select DE mode, MODE=”1”, VS and HS must pull high.
When select SYNC mode, MODE= ”0”, DE must be grounded.

Note 2: When input 18 bits RGB data, the two low bits of R,G and B data must be grounded.

Note 3: Data shall be latched at the falling edge of DCLK.

Note 4: Selection of scanning mode.

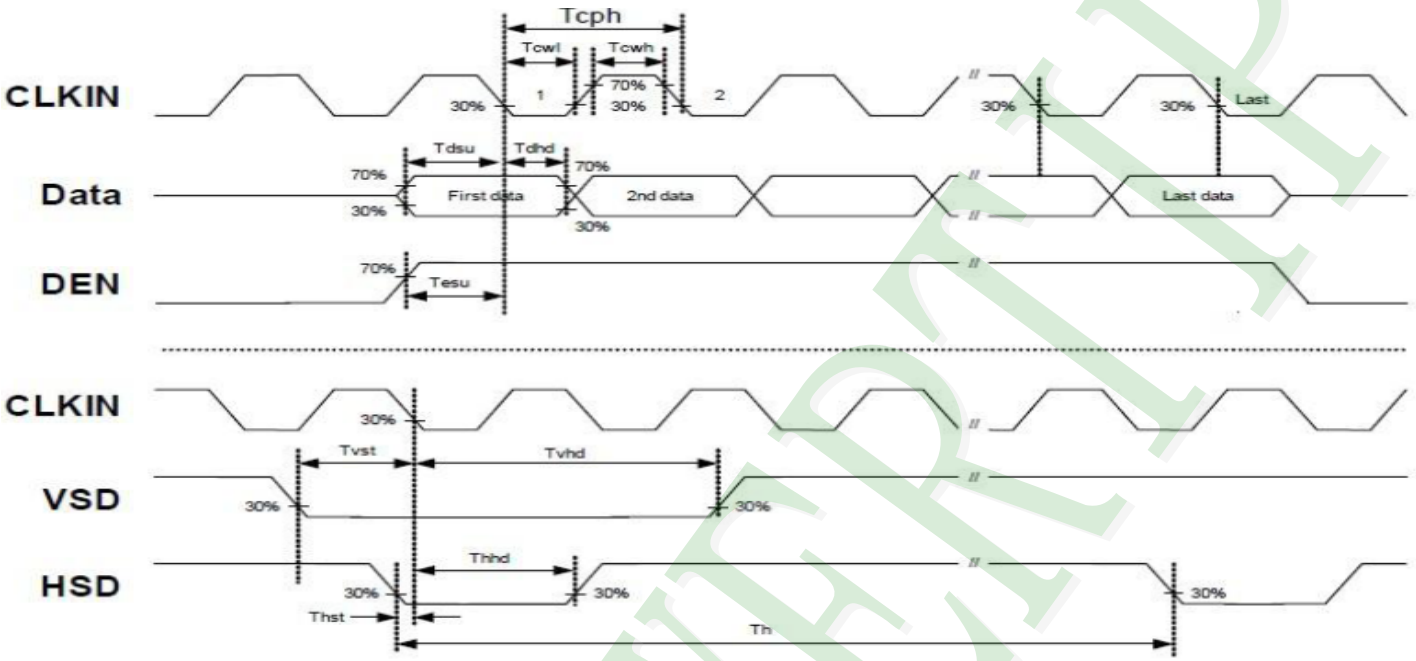
Setting of scan control input		Scanning direction
U/D	L/R	
GND	DV_{DD}	Up to down, left to right
DV_{DD}	GND	Down to up, right to left
GND	GND	Up to down, right to left
DV_{DD}	DV_{DD}	Down to up, left to right

Note 5: Global reset pin. Active low to enter reset state. Suggest to connect with an RC reset circuit for stability. Normally pull high.

Note 6: Dithering function enable control, normally pull high.
When DITHB=”1”,Disable internal dithering function.
When DITHB=”0”,Enable internal dithering function.

2.3 Timing Characteristics

2.3.1 Signal AC Characteristics



Item	Symbol	Values			Unit	Remark
		Min	Typ	Max.		
HS setup time	T_{hst}	8	-	-	ns	
HS hold time	T_{hhd}	8	-	-	ns	
VS setup time	T_{vst}	8	-	-	ns	
VS setup time	T_{vhd}	8	-	-	ns	
VS setup time	T_{dsu}	8	-	-	ns	
VS setup time	T_{dhd}	8	-	-	ns	
DE setup time	T_{esu}	8	-	-	ns	
DE hole time	T_{ehd}	8	-	-	ns	
DV_{DD} Power On Slew rate	T_{POR}	-	-	20	ms	From 0 to 90%DV_{DD}
RESET pulse width	T_{Rst}	1	-	-	ms	
DCLK cycle time	T_{coh}	20	-	-	ns	
DCLK pulse duty	T_{cwh}	40	50	60	%	

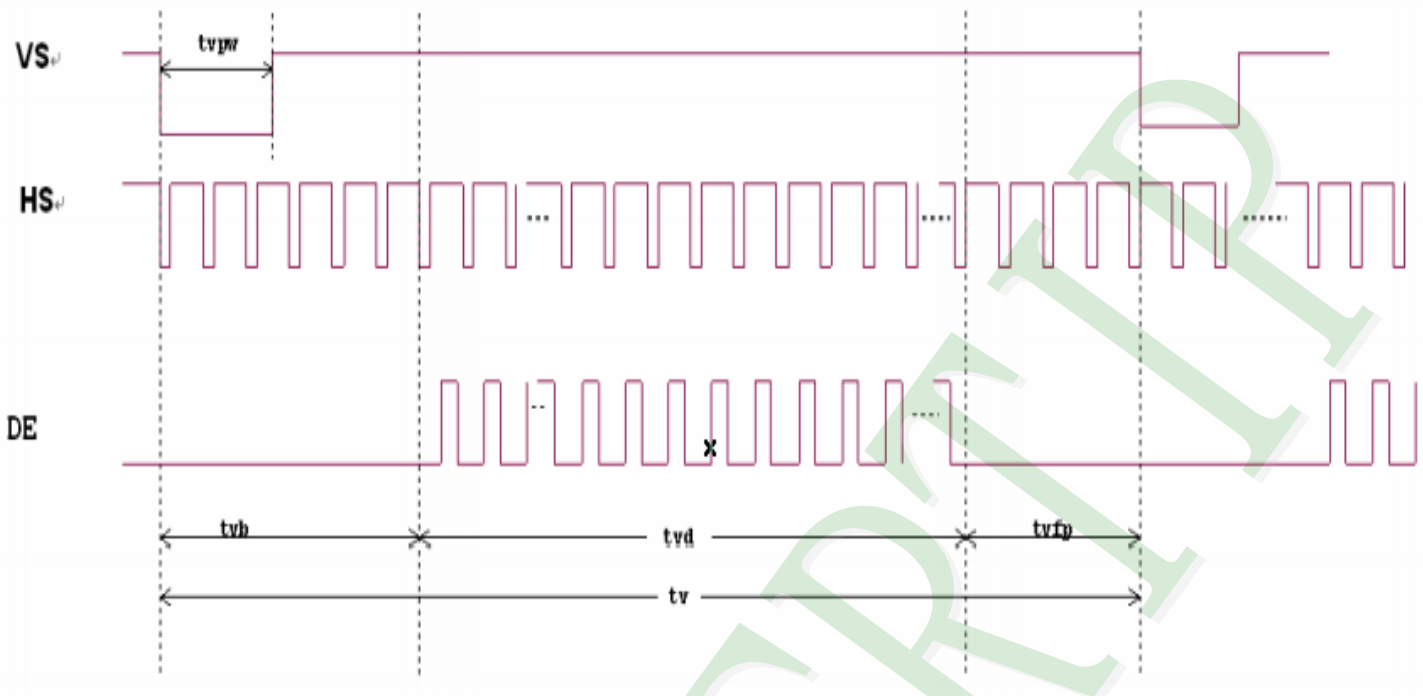
2.3.2 Input Timing Setting

Item	Symbol	Values			Unit	Remark
		Min.	Typ.	Max.		
Horizontal Display Area	Thd		800		DCLK	
DCLK Frequency	Fclk	26.4	33.3	46.8	MHz	
One Horizontal Line	Th	862	1056	1200	DCLK	
HS pulse width	Thpw	1		40	DCLK	
HS Blanking	Thb	46	46	46	DCLK	
HS Front Porch	Thfp	16	210	354	DCLK	

Item	Symbol	Values			Unit	Remark
		Min.	Typ.	Max.		
Vertical Display Area	Tvd		480		TH	
VS period time	Tv	510	525	650	TH	
VS pulse width	Tvpw	1		20	TH	
VS Blanking	Tvb	23	23	23	TH	
VS Front Porch	Tvfp	7	22	147	TH	

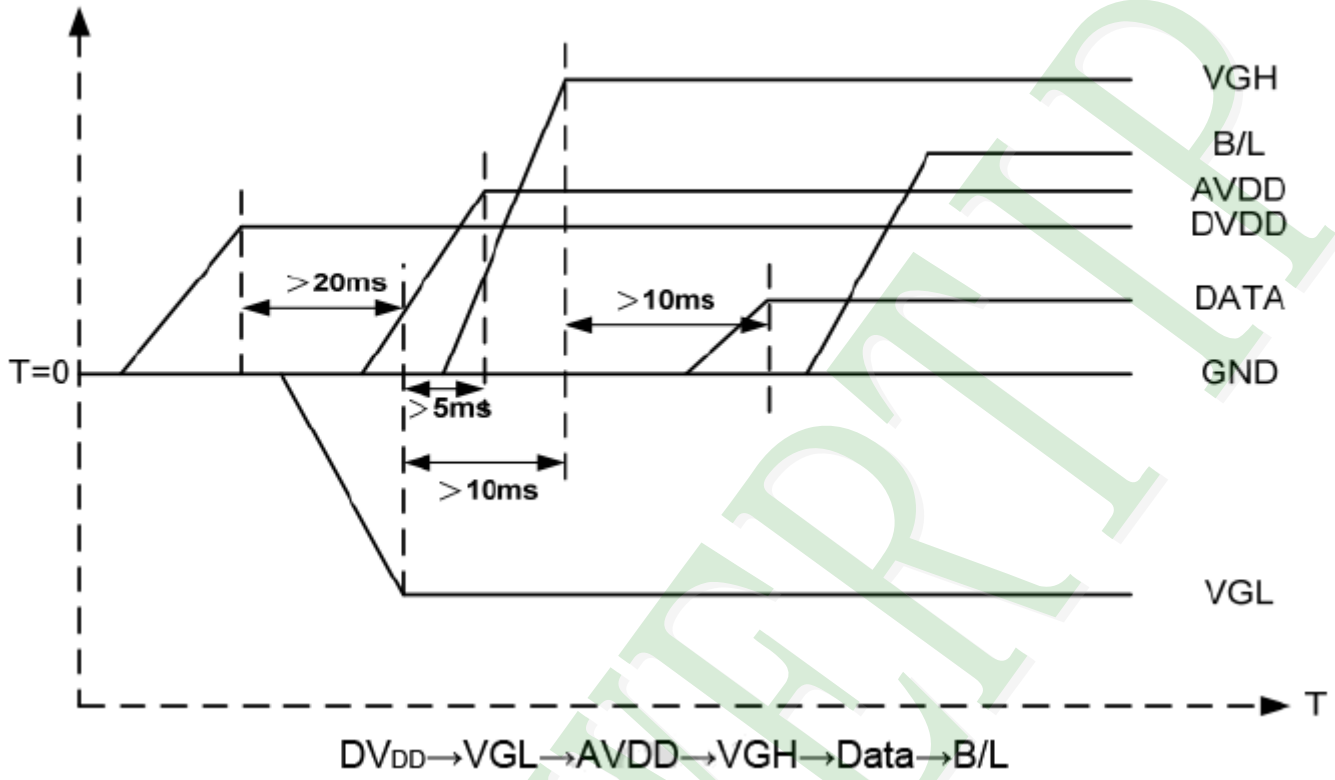
Horizontal input timing diaqram

Vertical input timing diaqram



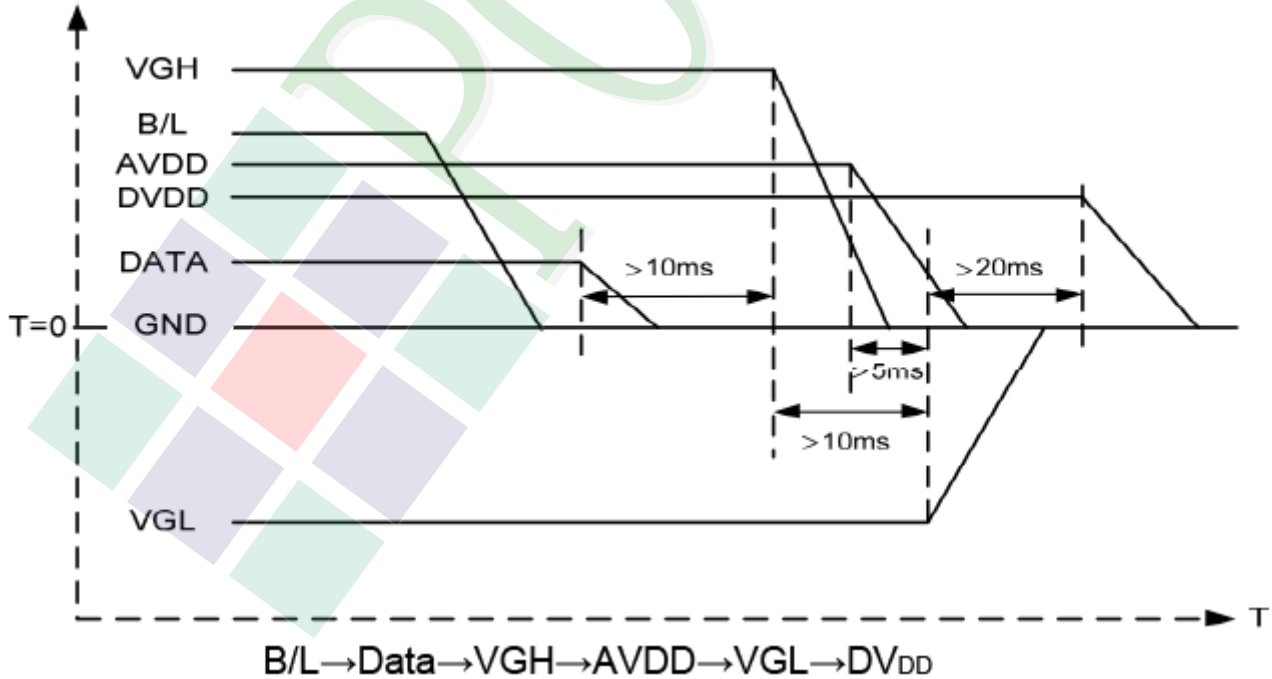
2.3.3 Power On/Off Characteristics

a. Power on:



DV_{DD}→VGL→AVDD→VGH→Data→B/L

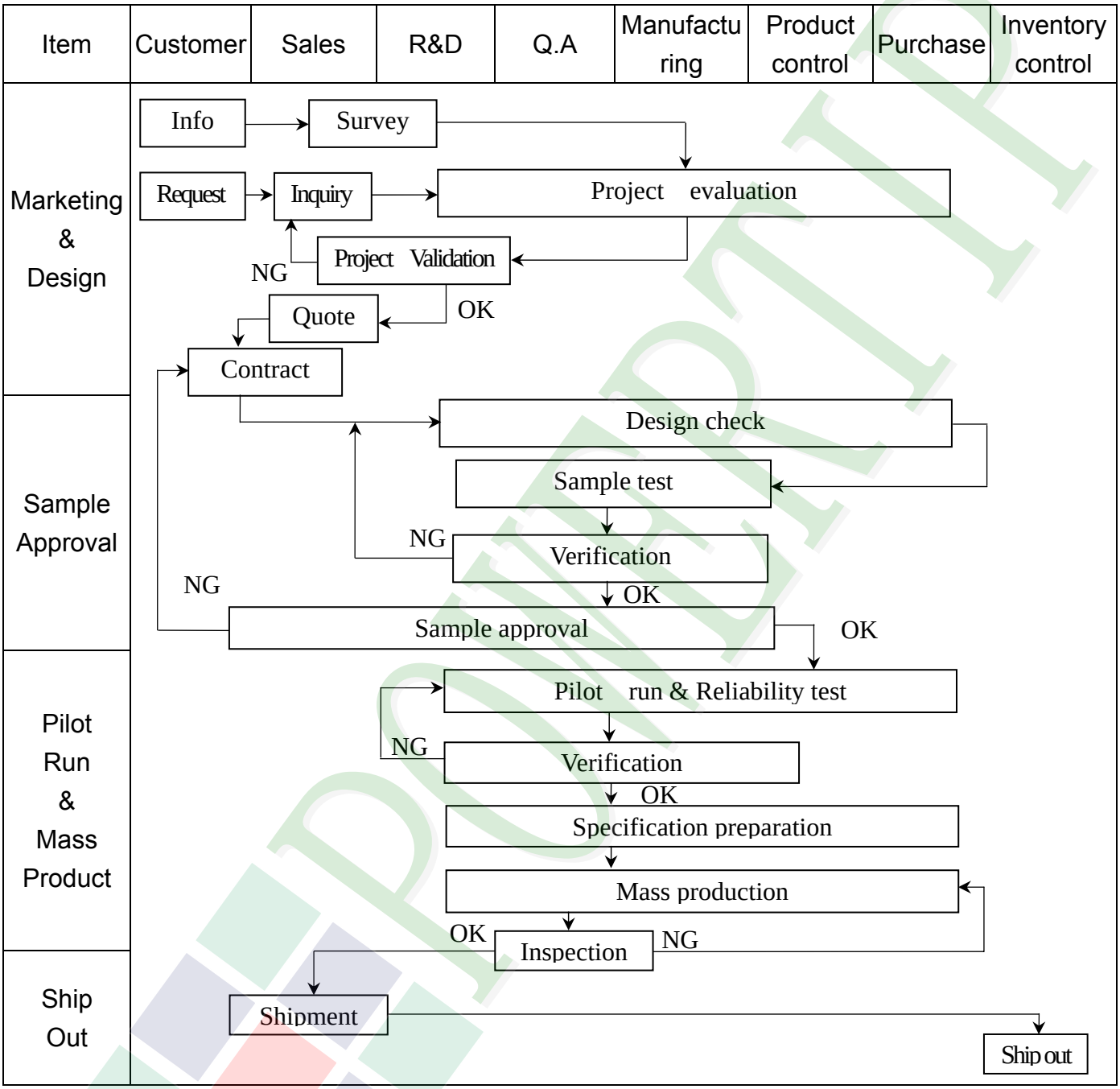
b. Power off:

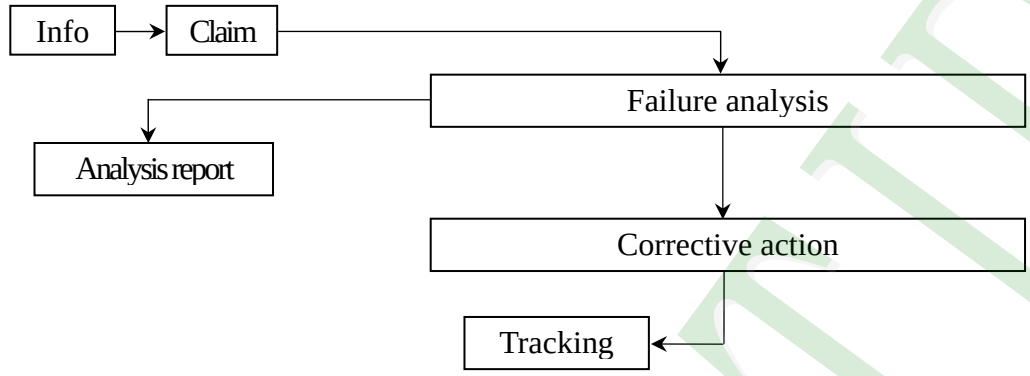


B/L→Data→VGH→AVDD→VGL→DV_{DD}

3. QUALITY ASSURANCE SYSTEM

3.1 Quality Assurance Flow Chart



Item	Customer	Sales	R&D	Q.A	Manufacturing	Product control	Purchase	Inventory control
Sales Service								
Q.A Activity	1. ISO 9001 Maintenance Activities 2. Process improvement proposal 3. Equipment calibration 4. Education And Training Activities 5. Standardization Management							

3.2. Inspection Specification

◆Scope：The document shall be applied to TFT-LCD Module for 3.5″ ~10″ (Ver.B01).

◆Inspection Standard：MIL-STD-105E Table Normal Inspection Single Sampling Level Ⅱ.

◆Equipment：Gauge、MIL-STD、Powertip Tester、Sample

◆Defect Level：Major Defect AQL： 0.4 ； Minor Defect AQL： 1.5

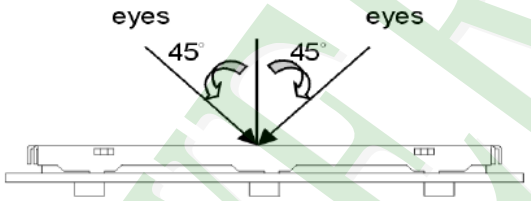
◆OUT Going Defect Level：Sampling.

◆Standard of the product appearance test：

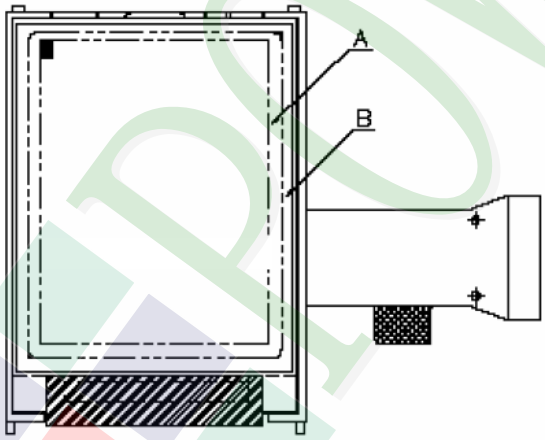
a. Manner of appearance test：

(1). The test best be under 20W×2 fluorescent light，and distance of view must be at 30 cm.

(2). The test direction is base on about around 45° of vertical line.



(3). Definition of area.



A area : viewing area

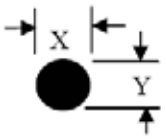
B area : Outside of viewing area

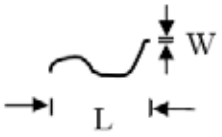
(4). Standard of inspection： (Unit：mm)

◆Specification For TFT-LCD Module 3.5″ ~10″ : (Ver.B01)

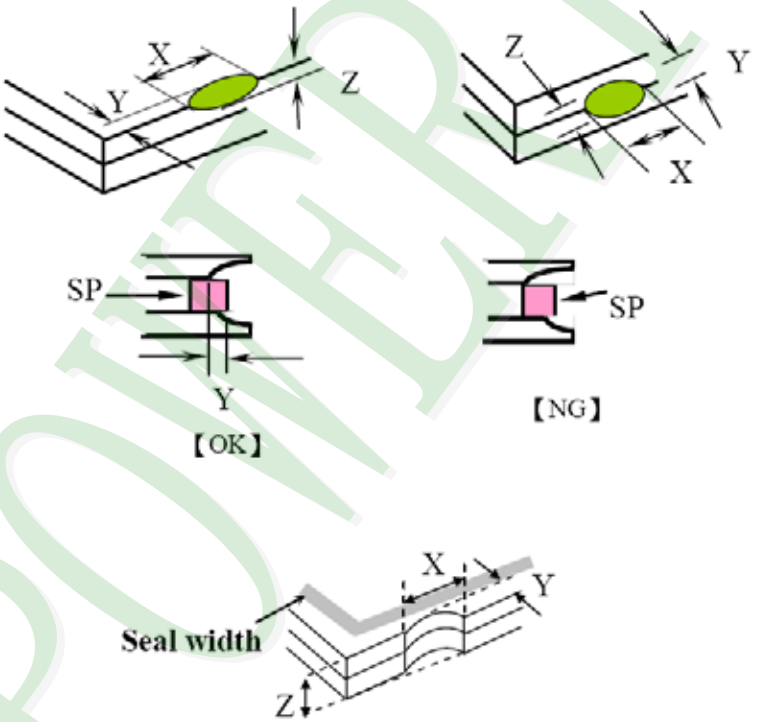
<table>
<tr><th>NO</th><th>Item</th><th>Criterion</th><th>Level</th></tr>
<tr><td rowspan="3">01</td><td rowspan="3">Product condition</td><td>1.1 The part number is inconsistent with work order of production.</td><td>Major</td></tr>
<tr><td>1.2 Mixed product types.</td><td>Major</td></tr>
<tr><td>1.3 Assembled in inverse direction.</td><td>Major</td></tr>
<tr><td>02</td><td>Quantity</td><td>2.1 The quantity is inconsistent with work order of production.</td><td>Major</td></tr>
<tr><td>03</td><td>Outline dimension</td><td>3.1 Product dimension and structure must conform to structure diagram.</td><td>Major</td></tr>
<tr><td rowspan="5">04</td><td rowspan="5">Electrical Testing</td><td>4.1 Missing line character and icon.</td><td>Major</td></tr>
<tr><td>4.2 No function or no display.</td><td>Major</td></tr>
<tr><td>4.3 Display malfunction.</td><td>Major</td></tr>
<tr><td>4.4 LCD viewing angle defect.</td><td>Major</td></tr>
<tr><td>4.5 Current consumption exceeds product specifications.</td><td>Major</td></tr>
<tr><td>05</td><td>Dot defect
(Bright dot、Dark dot)
On -display</td><td>
<table>
<tr><th colspan="2">Item</th><th>Acceptance (Q'ty)</th></tr>
<tr><td rowspan="4">Dot Defect</td><td>Bright Dot</td><td>≦ 4</td></tr>
<tr><td>Dark Dot</td><td>≦ 5</td></tr>
<tr><td>Joint Dot</td><td>≦ 3</td></tr>
<tr><td>Total</td><td>≦ 7</td></tr>
</table>
5.1 Inspection pattern：full white , full black , Red , Green and blue screens.
5.2 It is defined as dot defect if defect area ＞1/2 dot.
5.3 The distance between two dot defect ≧5 mm.
</td><td>Minor</td></tr>
</table>

◆Specification For TFT-LCD Module 3.5″ ~10″ : (Ver.B01)

<table>
<tr><th>NO</th><th>Item</th><th>Criterion</th><th>Level</th></tr>
<tr><td>06</td><td>Black or white dot、scratch、contamination
Round type
 

Φ=(x+y) / 2
Line type
 
</td><td>6.1 Round type (Non-display or display) :
<table><tr><th rowspan="2">Dimension (diameter : Φ)</th><th colspan="2">Acceptance (Q'ty)</th></tr><tr><th>A area</th><th>B area</th></tr><tr><td>Φ ≦ 0.25</td><td>Ignore</td><td rowspan="4">Ignore</td></tr><tr><td>0.25 < Φ ≦ 0.50</td><td>5</td></tr><tr><td>Φ > 0.50</td><td>0</td></tr><tr><td>Total</td><td>5</td></tr></table>
6.2 Line type(Non-display or display) :
<table><tr><th rowspan="2">Length (L)</th><th rowspan="2">Width (W)</th><th colspan="2">Acceptance (Q'ty)</th></tr><tr><th>A area</th><th>B area</th></tr><tr><td>---</td><td>W ≦ 0.03</td><td>Ignore</td><td rowspan="5">Ignore</td></tr><tr><td>L ≦10.0</td><td>0.03 < W ≦ 0.05</td><td>4</td></tr><tr><td>L ≦5.0</td><td>0.05 < W ≦ 0.10</td><td>2</td></tr><tr><td>---</td><td>W >0.10</td><td>As round type</td></tr><tr><td colspan="2">Total</td><td>5</td></tr></table></td><td>Minor</td></tr>
<tr><td>07</td><td>Polarizer Bubble</td><td><table><tr><th rowspan="2">Dimension (diameter : Φ)</th><th colspan="2">Acceptance (Q'ty)</th></tr><tr><th>A area</th><th>B area</th></tr><tr><td>Φ ≦ 0.25</td><td>Ignore</td><td rowspan="5">Ignore</td></tr><tr><td>0.25 < Φ ≦ 0.50</td><td>4</td></tr><tr><td>0.50 < Φ ≦ 0.80</td><td>1</td></tr><tr><td>Φ > 0.80</td><td>0</td></tr><tr><td>Total</td><td>5</td></tr></table></td><td>Minor</td></tr>
</table>

◆Specification For TFT-LCD Module 3.5″ ~10″ : (Ver.B01)

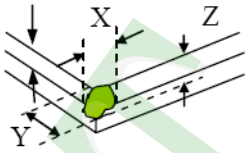
NO	Item	Criterion	Level
08	The crack of glass	Symbols : X : The length of crack Y : The width of crack. Z : The thickness of crack W : terminal length t : The thickness of glass a : LCD side length 8.1 General glass chip : 8.1.1 Chip on panel surface and crack between panels:  	Minor

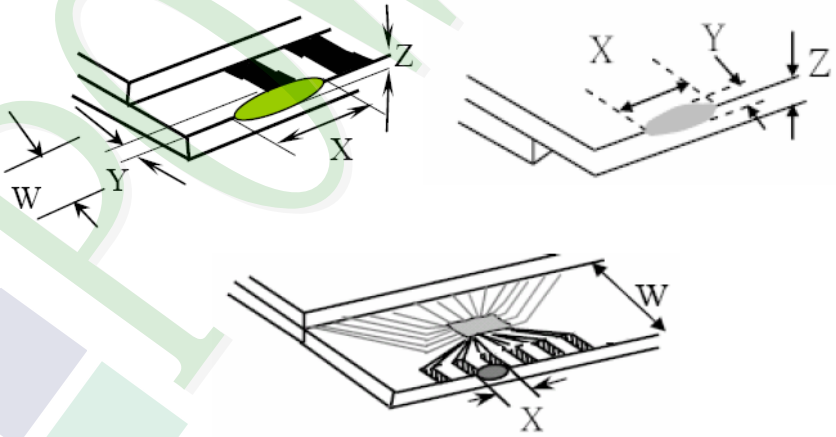
X	Y	Z
≦ a	Crack can't enter viewing area	≦1/2 t
≦ a	Crack can't exceed the half of SP width.	1/2 t < Z ≦2 t

◆Specification For TFT-LCD Module 3.5″ ~10″ : (Ver.B01)

<table>
<tr><th>NO</th><th>Item</th><th>Criterion</th><th>Level</th></tr>
<tr><td rowspan="2">08</td><td rowspan="2">The crack of glass</td><td>Symbols :

X : The length of crack Y : The width of crack.
Z : The thickness of crack W : terminal length
t : The thickness of glass a : LCD side length

8.1.2 Corner crack :
 

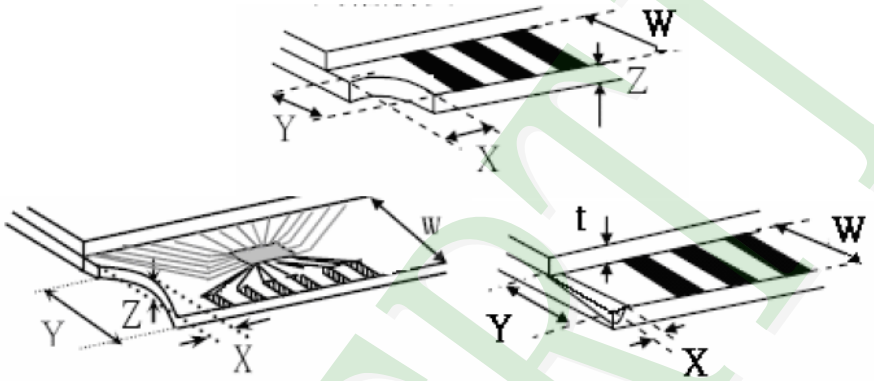
<table>
<tr><th>X</th><th>Y</th><th>Z</th></tr>
<tr><td>≦1/5 a</td><td>Crack can’t enter viewing area</td><td>Z ≦ 1/2 t</td></tr>
<tr><td>≦1/5 a</td><td>Crack can’t exceed the half of SP width.</td><td>1/2 t < Z ≦ 2 t</td></tr>
</table></td><td></td></tr>
<tr><td>8.2 Protrusion over terminal :
8.2.1 Chip on electrode pad :
 

<table>
<tr><th></th><th>X</th><th>Y</th><th>Z</th></tr>
<tr><td>Front</td><td>≦ a</td><td>≦ 1/2 W</td><td>≦ t</td></tr>
<tr><td>Back</td><td>≦ a</td><td>≦ W</td><td>≦ 1/2 t</td></tr>
</table></td><td>Minor</td></tr>
</table>

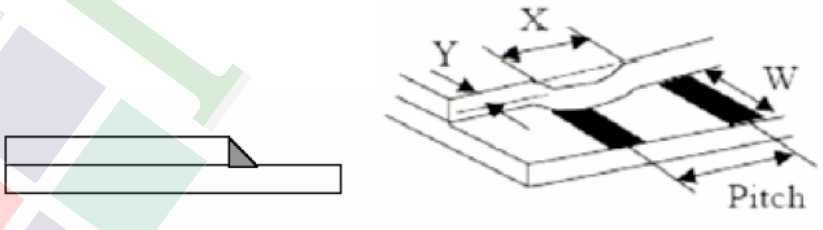
◆Specification For TFT-LCD Module 3.5″ ~10″ : (Ver.B01)

<table>
<tr><th>NO</th><th>Item</th><th>Criterion</th><th>Level</th></tr>
<tr><td>08</td><td>The crack of glass</td><td>
Symbols :

X : The length of crack Y : The width of crack.
Z : The thickness of crack W : terminal length
t : The thickness of glass a : LCD side length

8.2.2 Non-conductive portion :


<table>
<tr><th>X</th><th>Y</th><th>Z</th></tr>
<tr><td>≦ 1/3 a</td><td>≦ W</td><td>≦t</td></tr>
</table>
⊙ If the chipped area touches the ITO terminal, over 2/3 of the ITO must remain and be inspected according to electrode terminal specifications.

8.2.3 Glass remain :


<table>
<tr><th>X</th><th>Y</th><th>Z</th></tr>
<tr><td>≦ a</td><td>≦ 1/3 W</td><td>≦t</td></tr>
</table>
</td><td>Minor</td></tr>
</table>

4. RELIABILITY TEST

4.1 Reliability Test Condition

(Ver.B01)

NO.	TEST ITEM	TEST CONDITION
1	High Temperature Storage Test	Keep in +80 ±2℃ 96 hrs Surrounding temperature, then storage at normal condition 4hrs.
2	Low Temperature Storage Test	Keep in -30 ±2℃ 96 hrs Surrounding temperature, then storage at normal condition 4hrs.
3	High Temperature / High Humidity Storage Test	Keep in +60℃ / 90% R.H duration for 96 hrs Surrounding temperature, then storage at normal condition 4hrs. (Excluding the polarizer)
4	Temperature Cycling Storage Test	-30℃ → +25℃ → +80℃ → +25℃ (30mins) (5mins) (30mins) (5mins) 10 Cycle Surrounding temperature, then storage at normal condition 4hrs.
5	ESD Test	Air Discharge: Apply 2 KV with 5 times Discharge for each polarity +/- | Contact Discharge: Apply 250 V with 5 times discharge for each polarity +/- 1. Temperature ambiance : 15℃～35℃ 2. Humidity relative : 30%～60% 3. Energy Storage Capacitance(Cs+Cd) : 150pF±10% 4. Discharge Resistance(Rd) : 330Ω±10% 5. Discharge, mode of operation : Single Discharge (time between successive discharges at least 1 sec) (Tolerance if the output voltage indication : ±5%)
6	Vibration Test (Packaged)	1. Sine wave 10 55 Hz frequency (1 min) 2. The amplitude of vibration :1.5 mm 3. Each direction (X、Y、Z) duration for 2 Hrs
7	Drop Test (Packaged)	Packing Weight (Kg) / Drop Height (cm): 0 ~ 45.4 : 122 45.4 ~ 90.8 : 76 90.8 ~ 454 : 61 Over 454 : 46 Drop direction :※1 corner / 3 edges / 6 sides each 1times

5. PRECAUTION RELATING PRODUCT HANDLING

5.1 SAFETY

5.1.1 If the LCD panel breaks , be careful not to get the liquid crystal to touch your skin.

5.1.2 If the liquid crystal touches your skin or clothes , please wash it off immediately by using soap and water.

5.2 HANDLING

5.2.1 Avoid any strong mechanical shock which can break the glass.

5.2.2 Avoid static electricity which can damage the CMOS LSI—When working with the module , be sure to ground your body and any electrical equipment you may be using.

5.2.3 Do not remove the panel or frame from the module.

5.2.4 The polarizing plate of the display is very fragile. So , please handle it very carefully ,do not touch , push or rub the exposed polarizing with anything harder than an HB pencil lead (glass , tweezers , etc.)

5.2.5 Do not wipe the polarizing plate with a dry cloth , as it may easily scratch the surface of plate.

5.2.6 Do not touch the display area with bare hands , this will stain the display area.

5.2.7 Do not use ketonics solvent & aromatic solvent. Use with a soft cloth soaked with a cleaning naphtha solvent.

5.2.8 To control temperature and time of soldering is 320±10°Cand 3-5 sec.

5.2.9 To avoid liquid (include organic solvent) stained on LCM .

5.3 STORAGE

5.3.1 Store the panel or module in a dark place where the temperature is 25℃ ±5℃ and the humidity is below 65% RH.

5.3.2 Do not place the module near organics solvents or corrosive gases.

5.3.3 Do not crush , shake , or jolt the module.

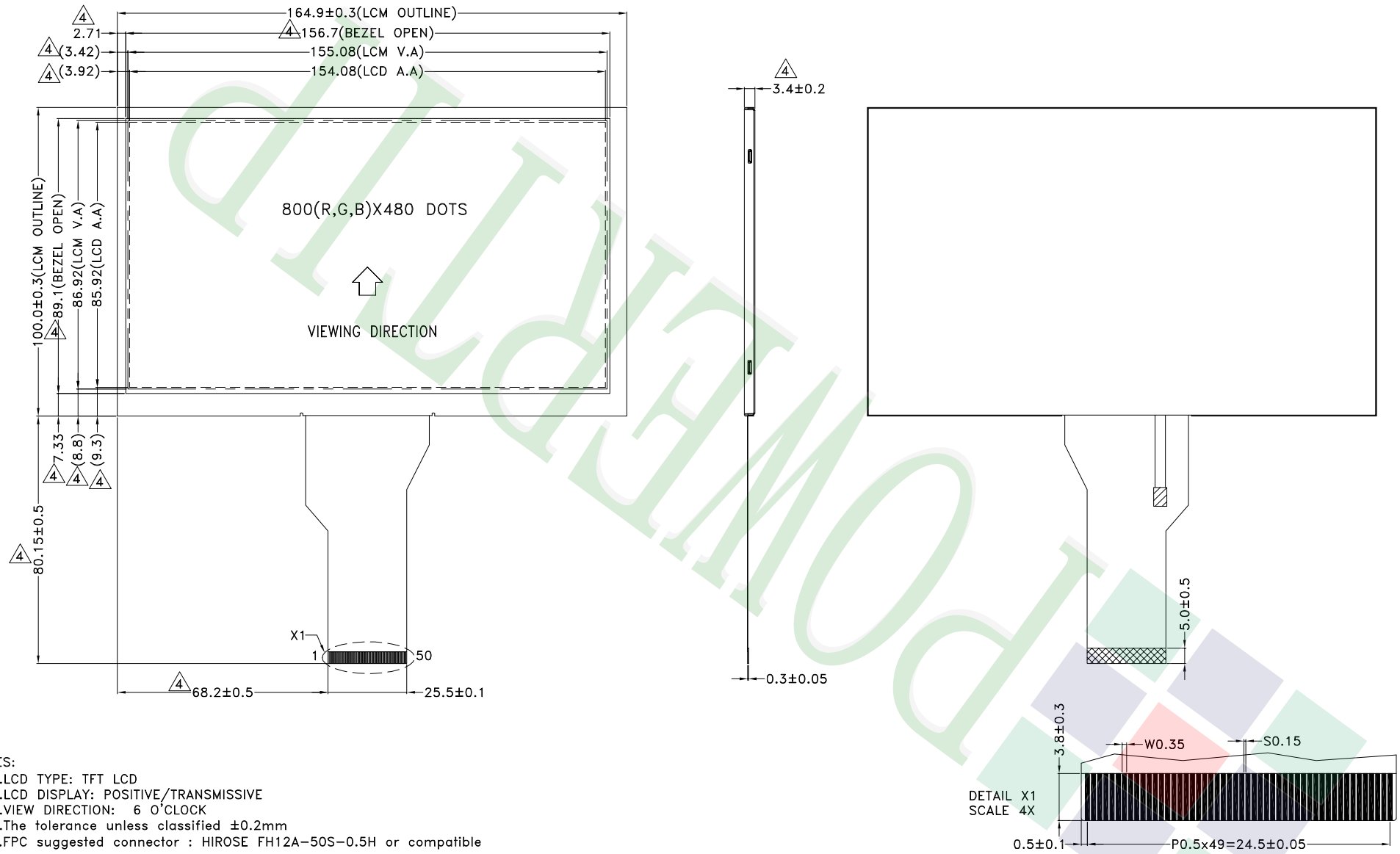
5.4 TERMS OF WARRANTY

5.4.1 Applicable warrant period

The period is within thirteen months since the date of shipping out under normal using and storage conditions.

5.4.2 Unaccepted responsibility

This product has been manufactured to your company's specification as a part for use in your company's general electronic products. It is guaranteed to perform according to delivery specifications. For any other use apart from general electronic equipment , we cannot take responsibility if the product is used in nuclear power control equipment , aerospace equipment , fire and security systems or any other applications in which there is a direct risk to human life and where extremely high levels of reliability are required.



NOTES:
1. LCD TYPE: TFT LCD
2. LCD DISPLAY: POSITIVE/TRANSMISSIVE
3. VIEW DIRECTION: 6 O'CLOCK
4. The tolerance unless classified ±0.2mm
5. FPC suggested connector : HIROSE FH12A-50S-0.5H or compatible

REV	REV BY	REVISER	DATE
007			
006			
005			
004	Modify Drawing	Mandy	2014/03/06
003	Modify DIM	Mandy	2014/01/13
002	Modify DIM	Mandy	2013/10/29
001	NEW DRAWING	Mandy	2013/10/24

PART NO: PH800480T013-IBA01

DRAWING NAME : LMD-PH800480T013-IBA01

TITLE: LCD MODULE DRAWING

久正光電股份有限公司
POWERTIP TECHNOLOGY CORPORATION

Design	Mandy hang	(3)	Surface		
Check	Tina Chen	Unit	MM	Material	
Approve	Linda Lee	Scale	1:1	Thickness	
		Page	1/1	Quantity	

Length(Min) (mm) / Tolerance / Precision	Precision Level
1 ~ 4	-
4 ~ 16	-
16 ~ 63	-
63 ~ 250	-
250 ~ 1000	-

PT-A-054-01